



Development of CVD Diamond Tracking Detectors for Experiments at High Luminosity Colliders

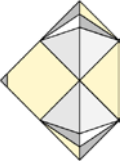
RD42 Status Report

Harris Kagan
for the RD42 Collaboration

LHCC Open Session - November 17, 2021

Outline of Talk

- The RD42 Collaboration
- The RD42 2019-2021 Program Milestones and Status
- Highlights of Recent Work
- The RD42 3 Year Proposal
- Summary



The 2021 RD42 Collaboration

The 2021 RD42 Collaboration

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- ⁴ INFN/University of Florence, Florence, Italy
- ⁵ GSI, Darmstadt, Germany
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- ³⁰ University of Bergen, Bergen, Norway
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31 Institutes

The RD42 Areas of Work, Publications, and more



Areas of work in RD42:

- Materials work (characterization of diamond)
- Work with manufacturers (feedback)
- Development of detectors (pad, strip, pixel, 3D)
- Development of machine devices (BLM, lumi)
- Irradiation (JSI, LANL) and Beam tests (CERN, PSI)
- Work with LHC experiments

RD42 meetings: <https://indico.cern.ch/category/3177/>

- 11 papers published in 2019, 4 papers published in 2020
- 3 conference talks in 2019, 3 conference talks in 2020
3 conference talks in 2021, (3 talks cancelled)
- 3 Ph.D. student expect to graduate in 2022
- 5 Ph.D. students continuing in 2022

RD42 Priorities of Research - 2021



- **Develop High Rate Beam Monitors**
 - Dedicated dual-gain readout ASIC (lumi/abort)
 - Includes ganged 3D sensors for added rad tolerance
- **Advancing 3D Sensors**
 - Study irradiated sensors
 - Develop 3D diamond pixel modules
 - Develop internal graphitic connections for added redundancy
 - Develop reduced column spacing to further improve rad tolerance
- **Radiation tolerance of pCVD and scCVD planar sensors**
 - Two complete publications of irradiation studies

2019-2021 Program Milestones and Status



2.1 Milestones: 3D Diamond Sensor Fabrication and Characterisation

2019

- Complete testbeam analysis of early 3D prototypes to quantify operating points, collected charge, efficiency – Done
- Irradiation of two early 3D prototype sensors configured as pad detectors to 10^{15} – Done
- Laser drilling $50\ \mu\text{m} \times 50\ \mu\text{m}$ cells with $2.6\ \mu\text{m}$ diameter columns with 99.9% yield – Done (Spatial Light Modulators is the key)
- 3D columns from etching process produced and evaluated – Done

2020

- Testbeam studies of irradiated 3D sensors configured as ganged detectors – Done
- Assess performance after fluence of 10^{15} – Done



2019-2021 Program Milestones and Status

- Scale up 3D columns produced by laser– Done
- Irradiation of 50 μm x 50 μm cells to 10^{16} – In progress

2021

- Final scale up of column production – produce 10 cm^2 sensors – Postponed due to shutdown of production lab
- Testbeam studies of sensors irradiated to 10^{16} – Postponed due to shutdown of resources
- Transfer column production procedures to industry – Postponed due to shutdown of resources
- Irradiation to fluences of 10^{17} – postponed due to shutdown of resources

2019-2021 Program Milestones and Status



2.2 Milestones: HL-LHC Beam Monitoring Proof-of-Principle

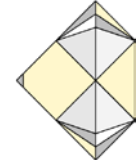
2019

- Produce first RD42 65nm HL-LHC beam loss/lumi ASIC – Done
- Assemble first HL-LHC beam loss monitor station – Done
- Test at PSI with fluxes up to 20 MHz – Done
- Irradiate one station to a fluence of 10^{15} – Done

2020

- Produce second 65 nm HL-LHC beam loss/lumi ASIC – Done
- Test un-irradiated beam loss station with CalypsoC ASIC in test beam at CERN – Done (results in this talk)
- Test irradiated beam loss station w/MIPs at CERN – Postponed waiting for material

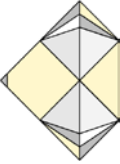
2019-2021 Program Milestones and Status



2021

- Work w/manufacturers to produce pCVD diamond for HL-LHC systems – Done
- Preselect, metalise diamond for the ATLAS BCM' project – In progress, waiting for material from manufacturer
- Beam test of BCM' modules using the RD42 65nm CalypsoC ASIC – Done (results in this talk)

2019-2021 Program Milestones and Status



2.3 Milestones: Development of pCVD Diamond Material

2019

- Develop edge-TCT to measure the internal electric field configuration of CVD material – Done
- Work w/manufacturers to reduce surface imperfections and voids to less than $1/\text{cm}^2$ – Done

2020

- Work w/manufacturers to produce first pCVD material with 400 μm collection distance in finished 500 μm part – In progress, waiting for material

2021

- Work w/manufacturers to reduce the as-grown charge collection distance uniformity across 12 cm wafers to $< 2\%$ - In progress

2019-2021 Program Milestones and Status



2.4 Milestones: Development of 3D pCVD Pixel Module Prototypes

2019

- Fabricate and characterize a number of 3D diamond pixel devices with the latest advances with 50 μm x 50 μm cell size – Done
- Irradiate a small number of 3D diamond pixel devices up to $10^{15}/\text{cm}^2$ – Done
- Characterize radiation tolerance of 3D pixel devices in beam tests with the RD53 chip – Postponed

2020

- Fabricate and characterize a number of 3D diamond pixel devices with the latest advances with 25 μm x 25 μm cell size – Postponed
- Irradiate a small number of 3D diamond pixel devices up to $10^{16}/\text{cm}^2$ – In progress



2019-2021 Program Milestones and Status

- Directly compare the 25 μm cells with the 50 μm cells in a beam test – Postponed to this proposal

2021

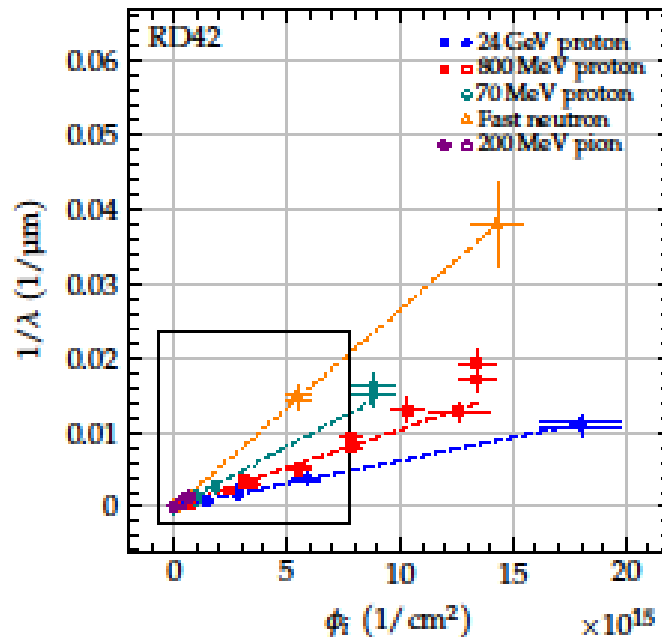
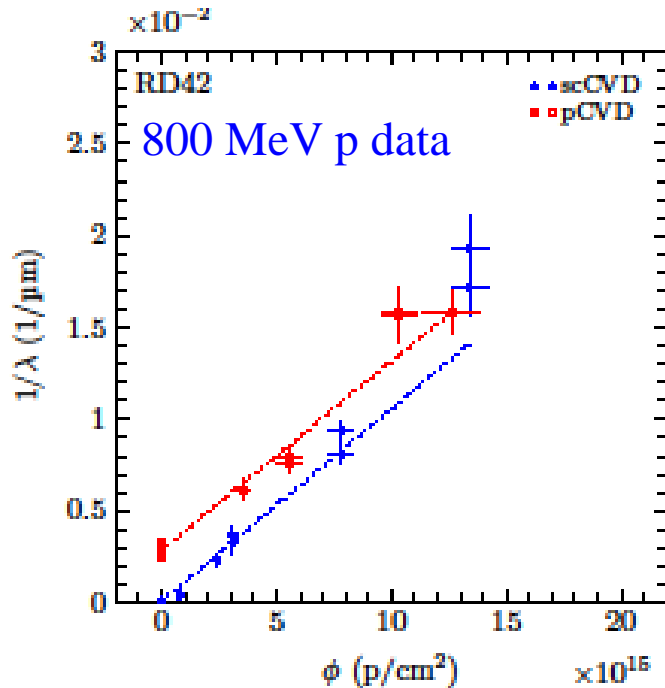
- Confirm radiation hardness of 3D diamond devices in beam tests up to 10^{17} hadrons/cm² – Postponed to this proposal
- Technology Transfer – Postponed to this proposal
- Construct and test pCVD diamond pixel based beam monitoring devices – Done



Highlights of Recent Work Accomplished

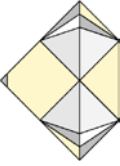
Radiation Tolerance Studies

- 1- Study 24 GeV p, 800 MeV p, 70 MeV p, 25 MeV p, Fast n, 200 MeV π
- 2- Determine damage constant for each using 1st-order model
- 3- Determine Universal Damage Curve scaling parameters
- 4- Quantify signal response, uniformity vs dose



$$\frac{1}{\lambda} = \frac{1}{\lambda_0} + k\phi$$

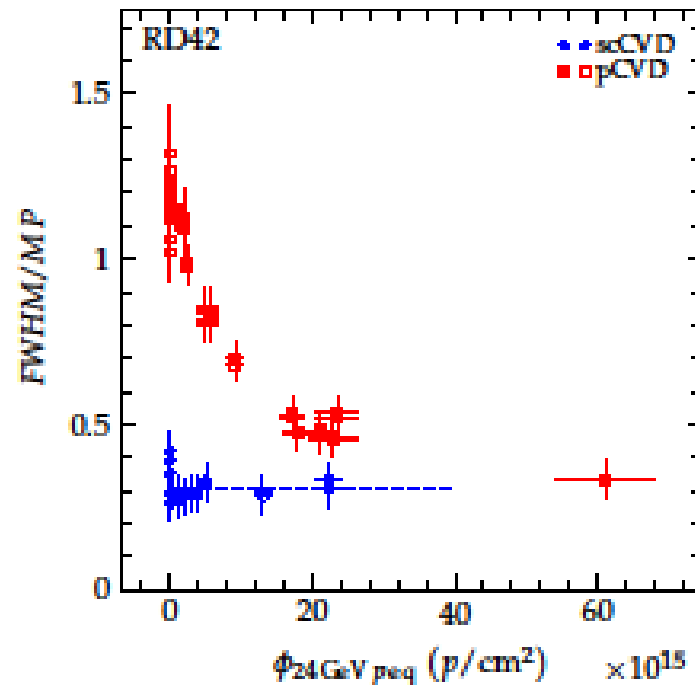
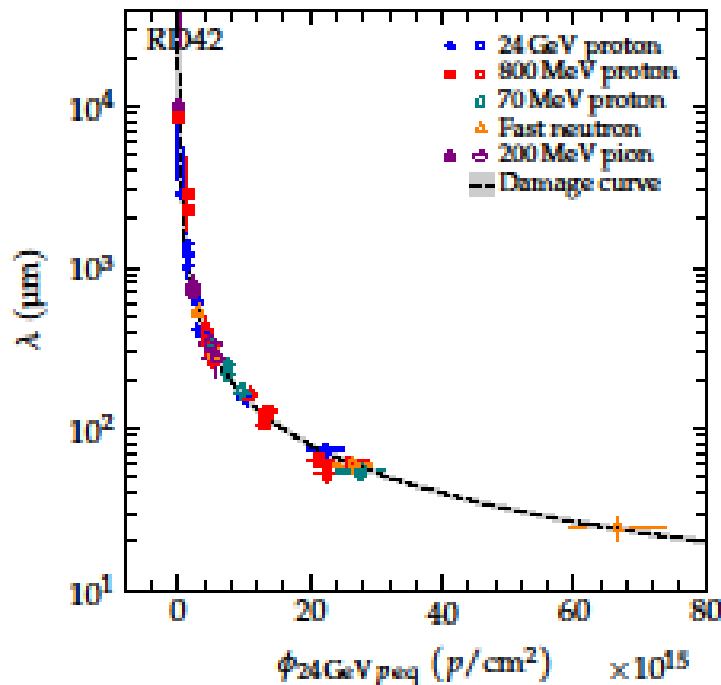
Particle Species	Relative Damage Constant, κ
24 GeV p	1
800 MeV p	1.67 ± 0.09
70 MeV p	2.60 ± 0.29
25 MeV p	4.4 ± 1.2
Fast neutrons	4.3 ± 0.4
200 MeV π	3.2 ± 0.8

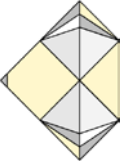


Highlights of Recent Work Accomplished

Radiation Tolerance Studies

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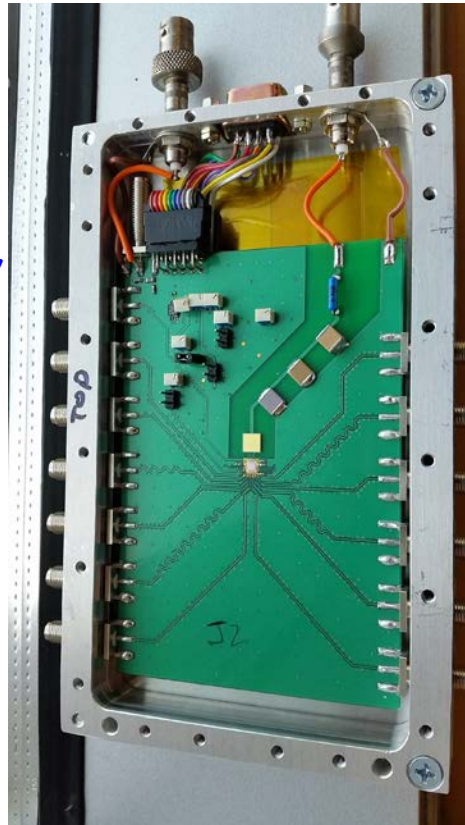


Highlights of Recent Work Accomplished

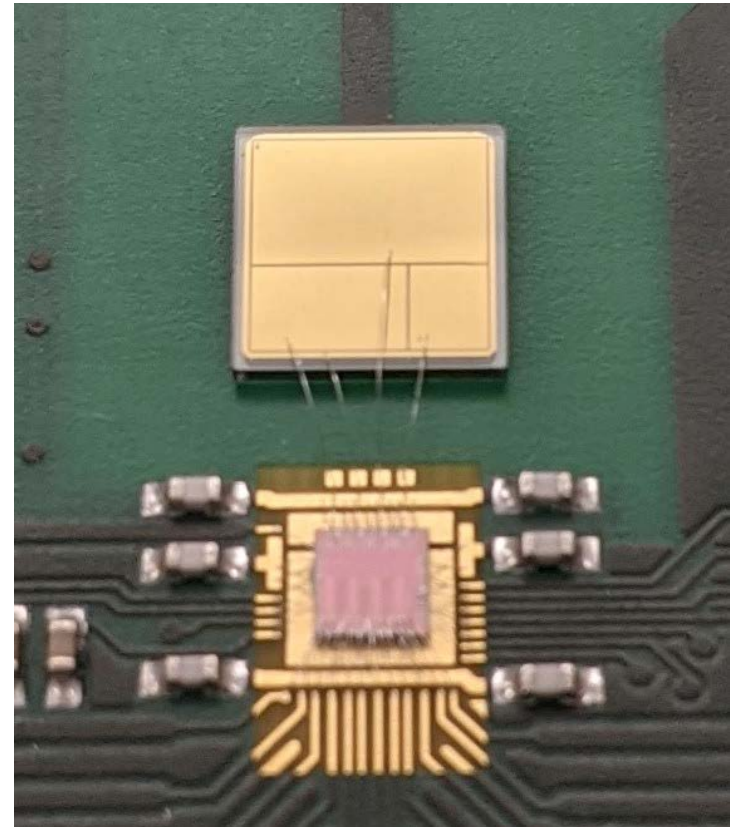
Collaboration with CERN/LHC Users - ATLAS

- 1-RD42 created Calypso ASIC for lumi/abort functionality
- 2-ATLAS BCM' will use Calypso ASIC w/diamond pad, 3D diamond, silicon
- 3-First beam test results (Aug, Oct, Nov 2021)

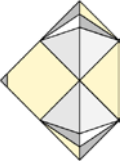
BCM' Module:
Pulser In,
Analog out(4),
LVDS+(4),
LVDS-(4)
→ SMA



BCM' 3-pad
diamond
detector
Area ratio
1:2:4.5



Calypso_C:

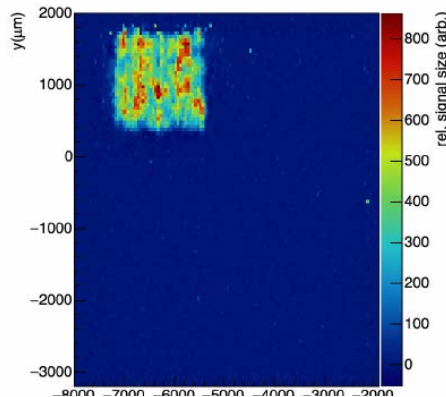


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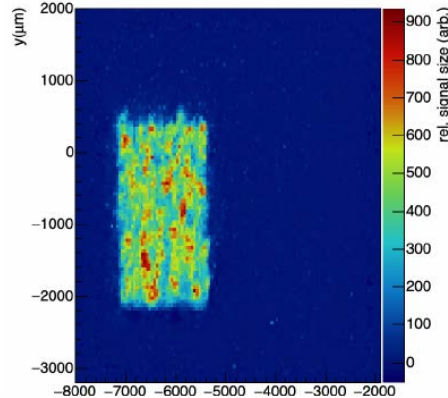
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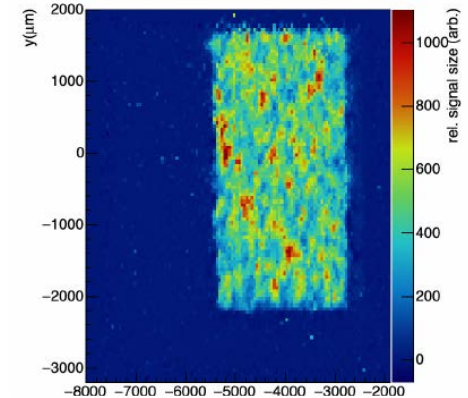
BCM' Module: Pad A1



BCM' Module: Pad A2



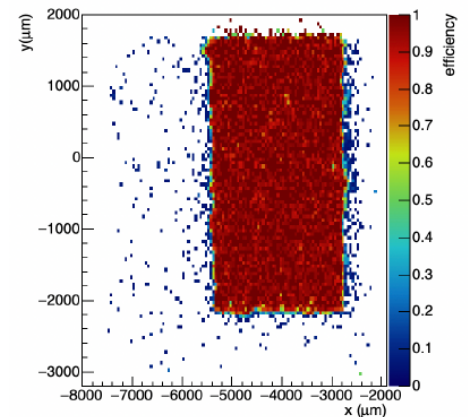
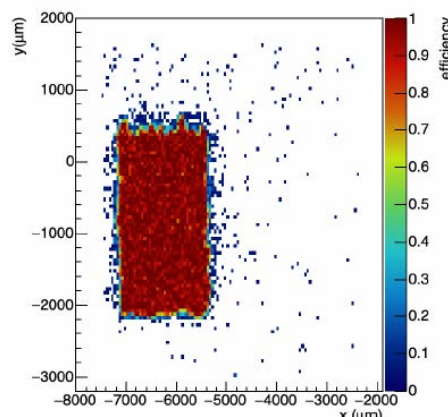
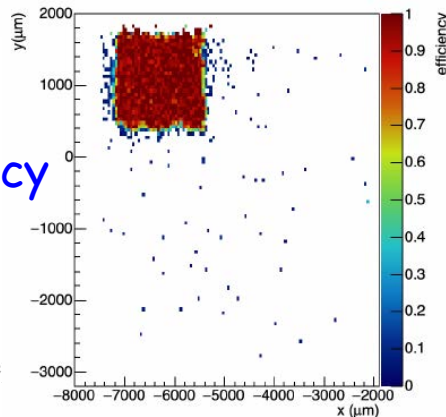
BCM' Module Pad A4.5

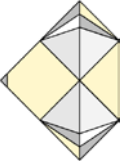


Pulse Height for trk in pad

Efficiency

RD42 Re



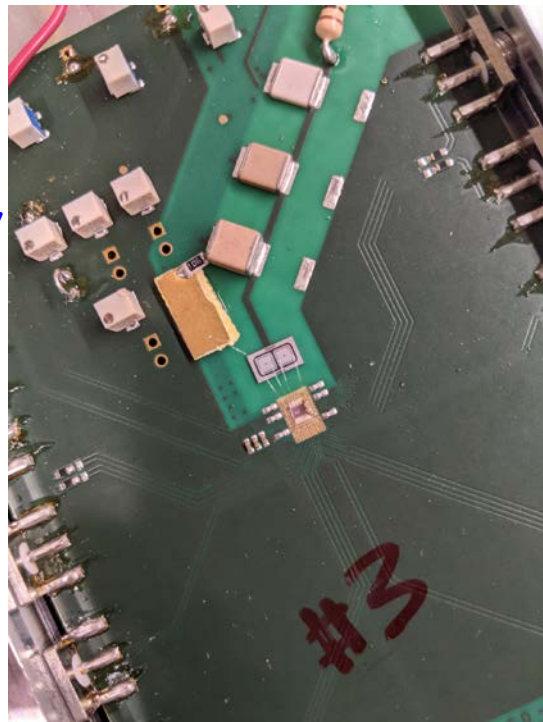


Highlights of Recent Work Accomplished

Collaboration with CERN/LHC Users - CMS

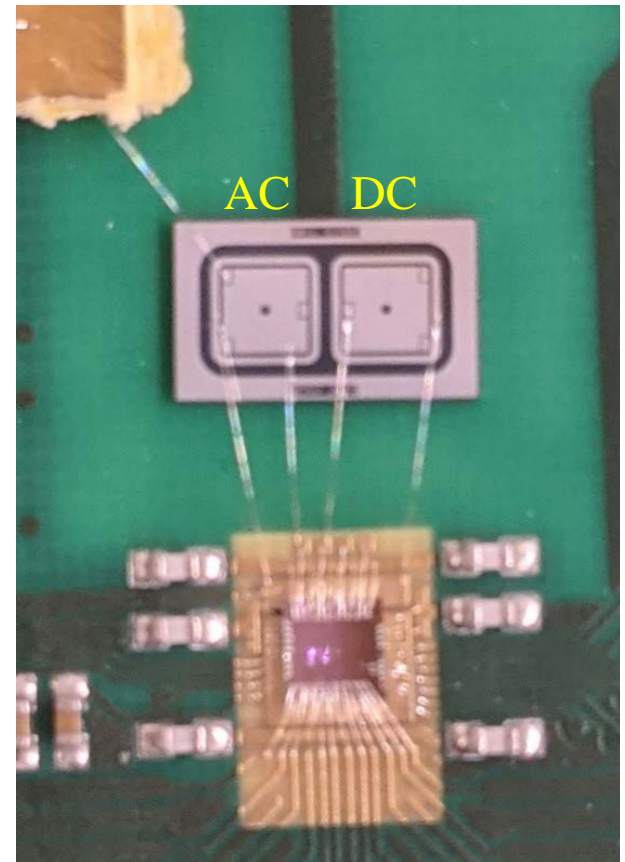
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- 2-CMS BCM' may use Calypso ASIC w/silicon pad detectors
- 3-First beam test results in MALTA Telescope (Oct 2021)

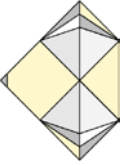
CMS Module:
Pulser In,
Analog out(4),
LVDS+(4),
LVDS-(4)
→ SMA



CMS
Silicon pad
detector
AC/DC
coupled

Calypso_C:





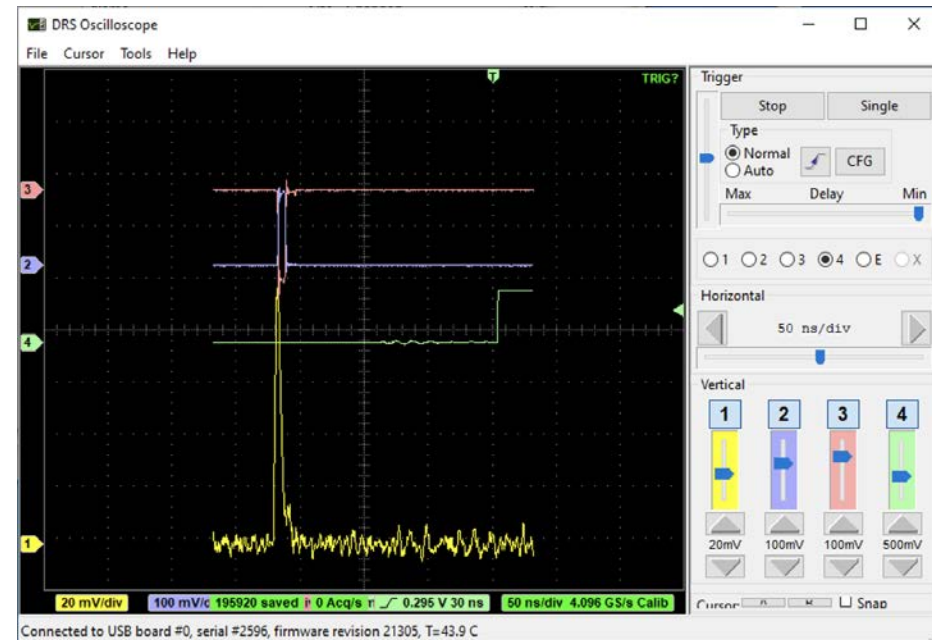
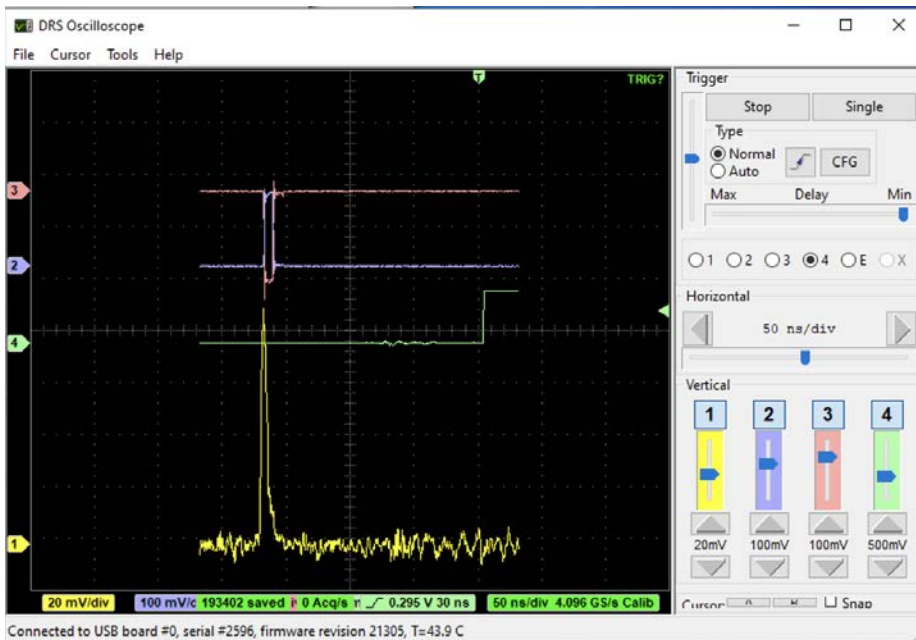
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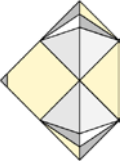
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CMS Si-Pad, -900V w/FD Event 8

CMS Si-Pad, -900V w/FD Event 9





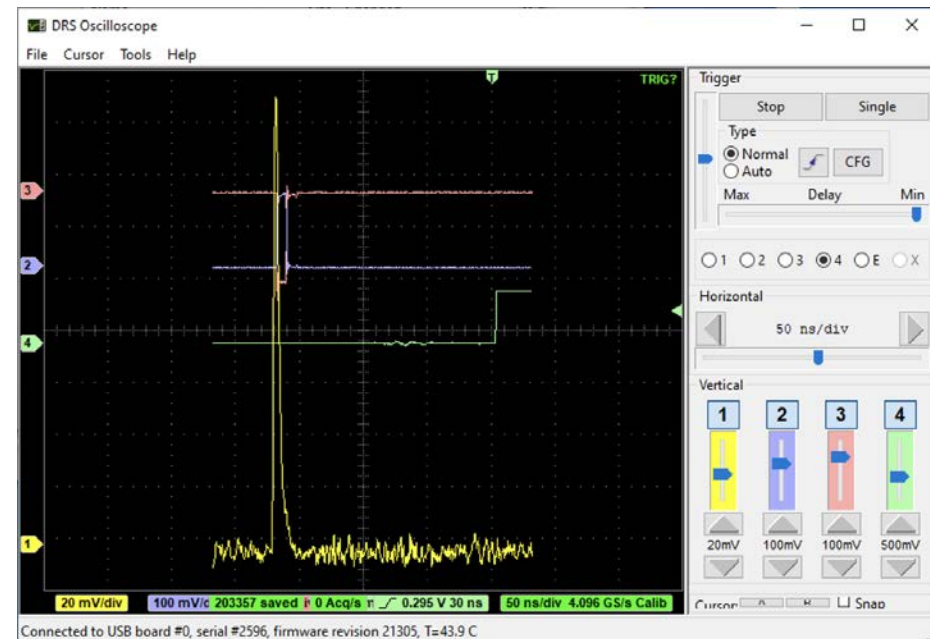
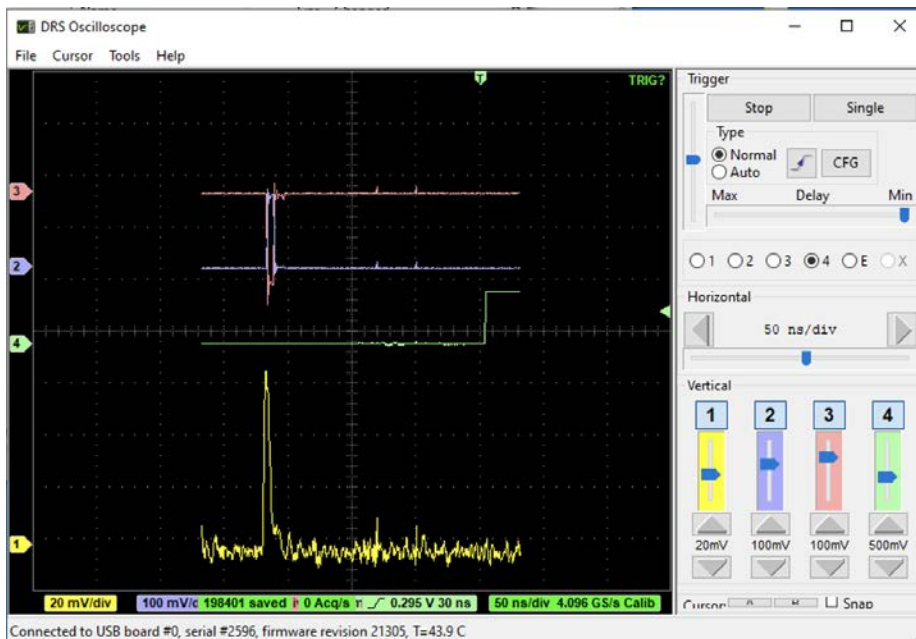
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CMS Si-Pad, -900V w/FD Event 10

CMS Si-Pad, -900V w/FD Event 11



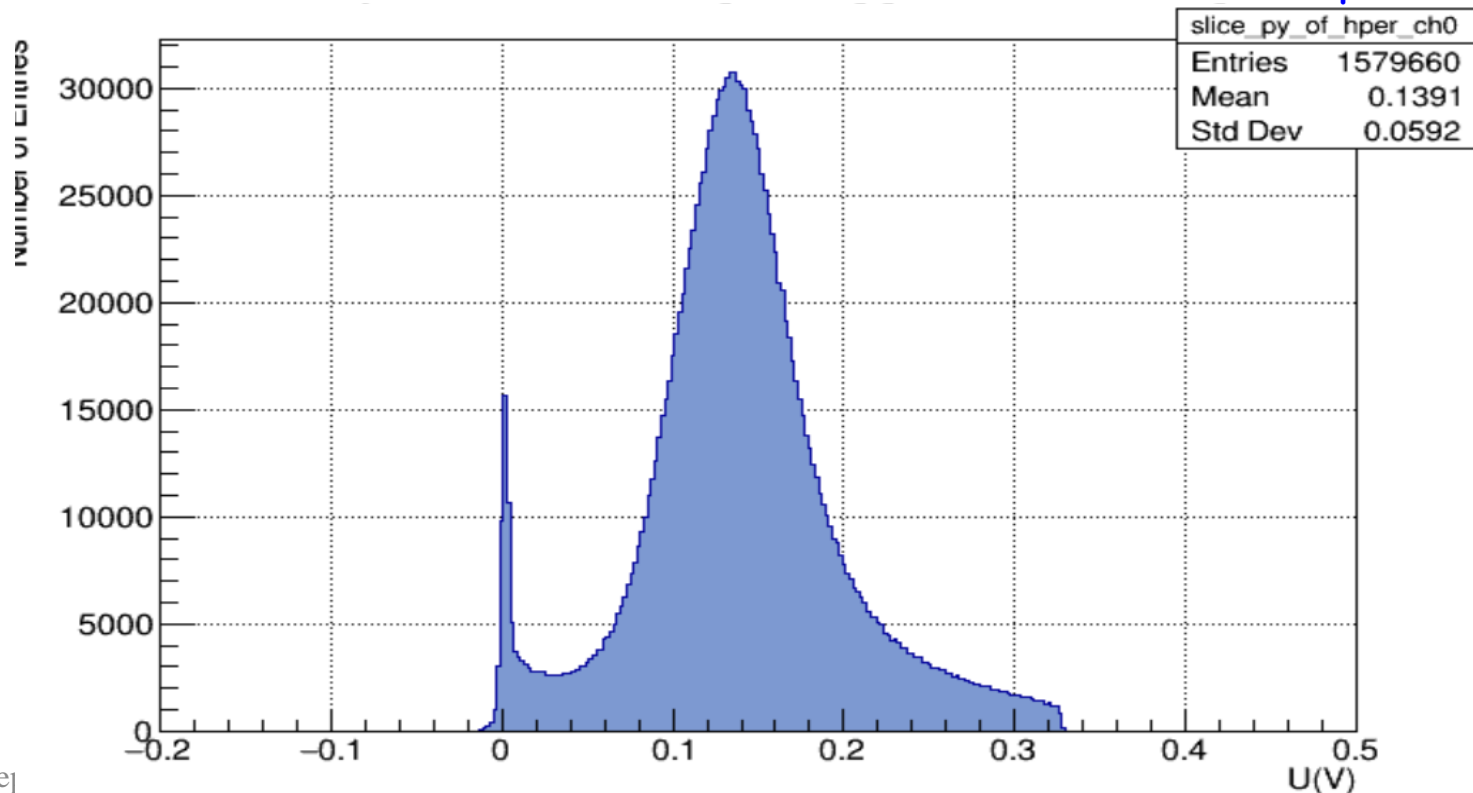


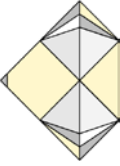
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CMS Si-Pad, -900V w/FD PH Distribution for trks in pad



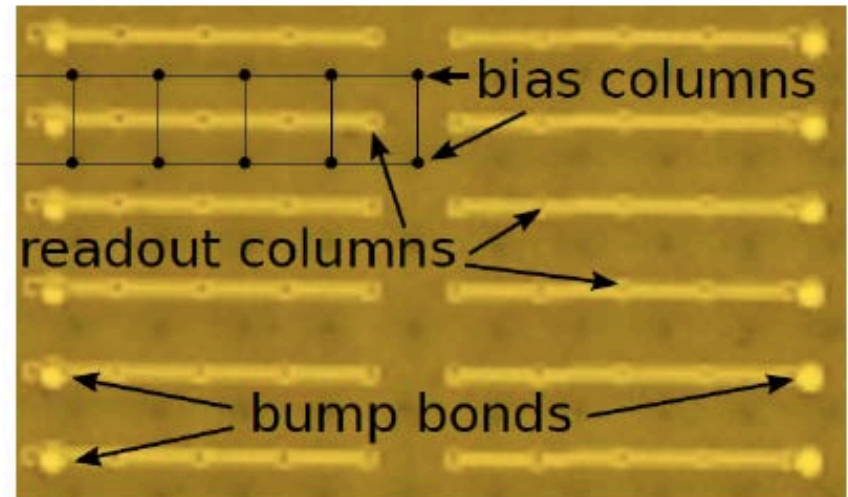
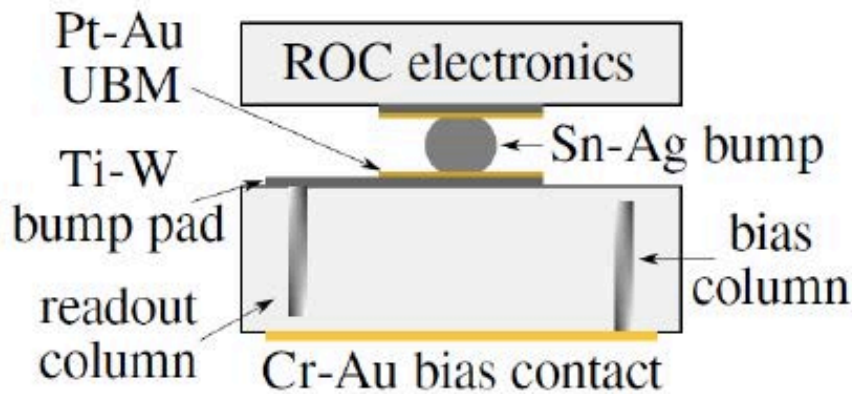


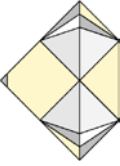
Highlights of Recent Work Accomplished

3D Diamond Pixel Detectors

- 1-RD42 showed 3D devices work first in scCVD then pCVD diamond
- 2-RD42 fabricated $50\mu\text{m} \times 50\mu\text{m}$ pixel detectors read out by ganging with (1x5) ATLAS or (3x2) CMS ASICs
- 3-In 2019 RD42 characterized the rad tolerance of 3D diamond devices
- 4-This past year RD42 constructed the first cage/grid structure

ATLAS 3D diamond pixel device (1 x 5 ganging)



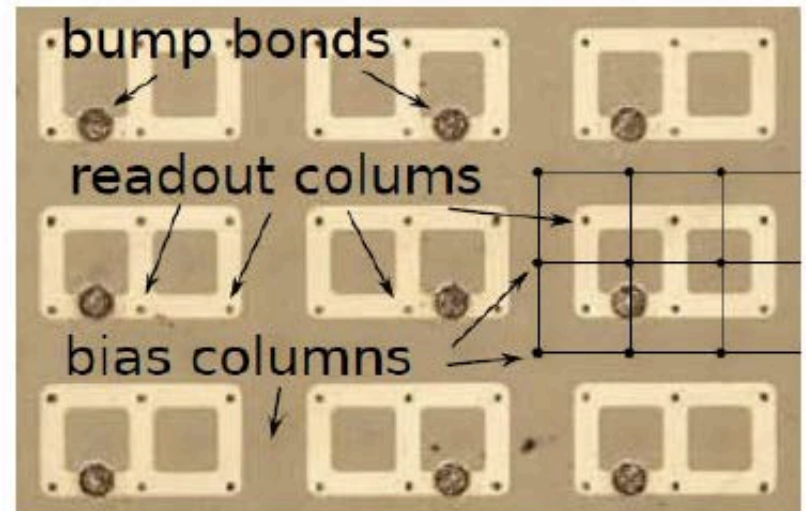
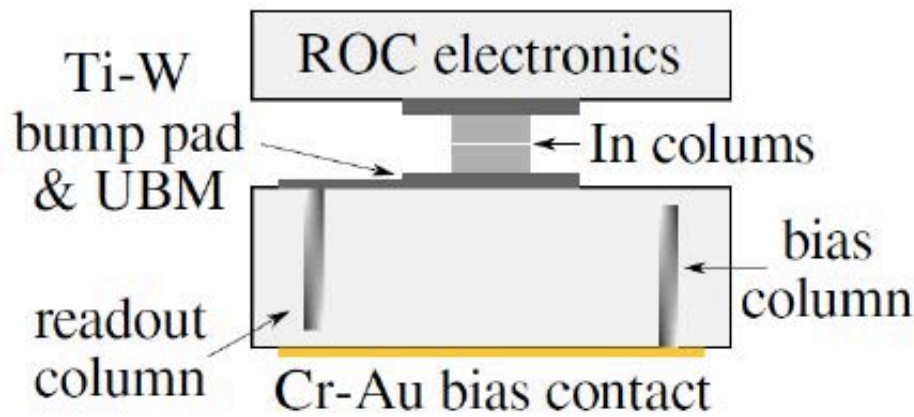


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- 3-In 2019 RD42 characterized the rad tolerance of 3D diamond devices
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CMS 3D diamond pixel device (3 x 2 ganging)



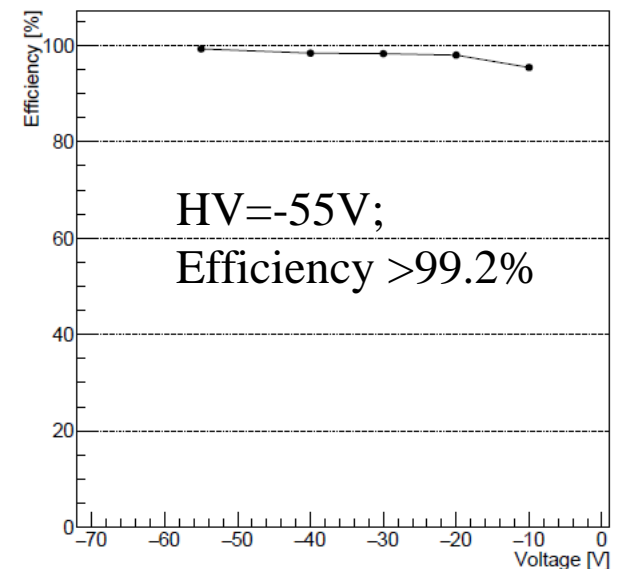
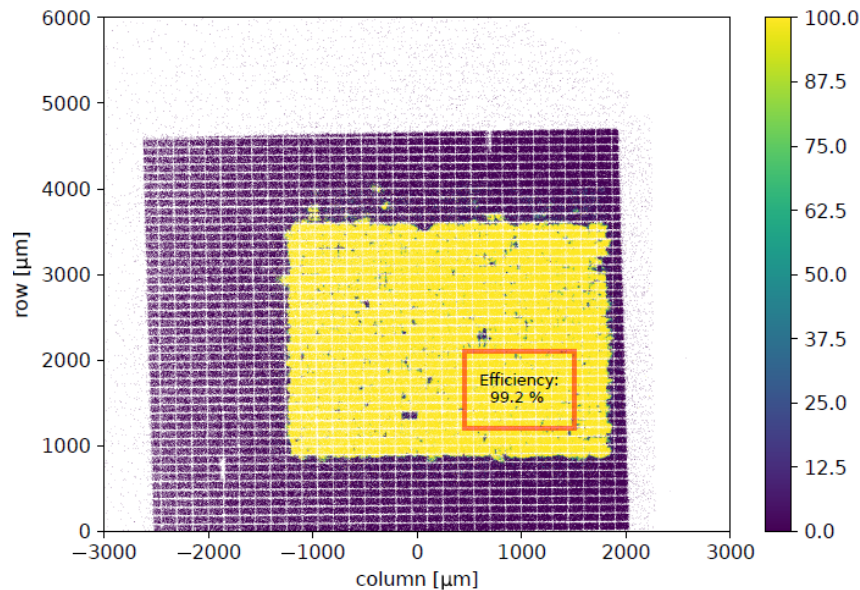
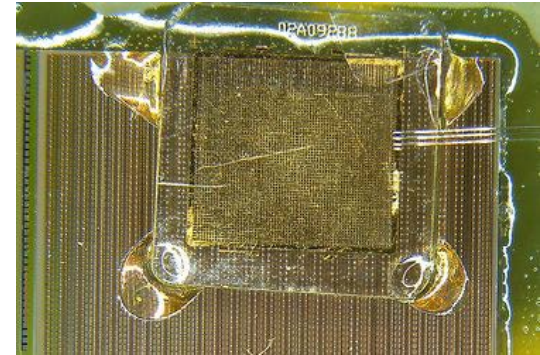


Highlights of Recent Work Accomplished

3D Diamond Pixel Detector Results

Preliminary Results (50 μm \times 50 μm cells)

- CMS pixel readout (3 \times 2) ganging
- Indium bumps
- LJU telescope (resolution \sim 3 μm)
- Red box-efficiency 99.2%

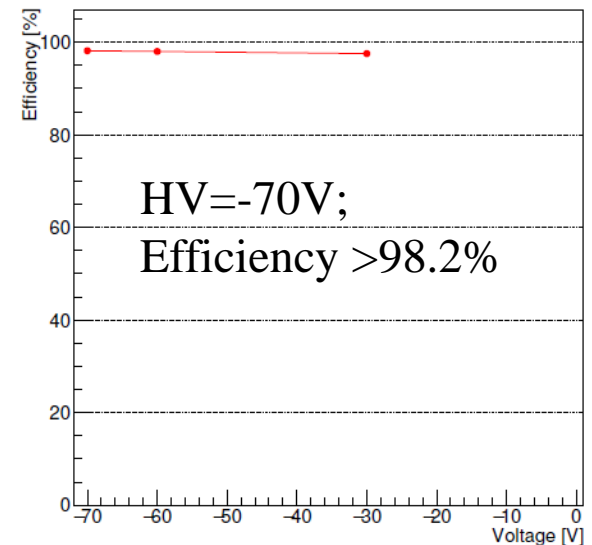
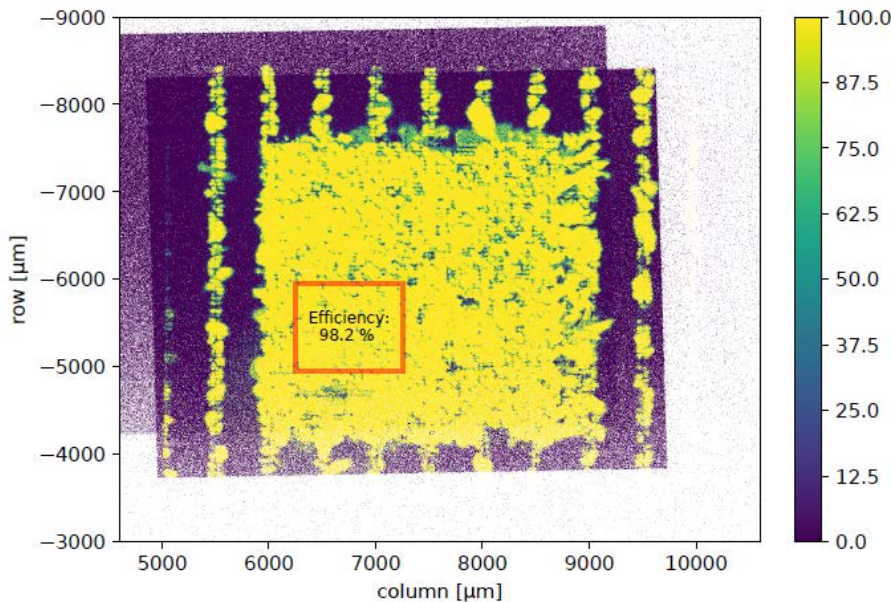
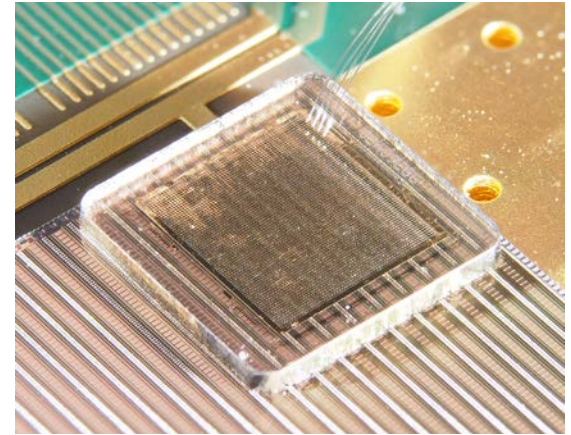


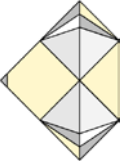
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3D Diamond Pixel Detector Results Preliminary Results (50 μm \times 50 μm cells)

- Atlas pixel readout (1 \times 5) ganging
- Tin-Silver bumps
- LJU telescope (resolution \sim 3 μm)
- Red box-efficiency 98.2%
- Inefficiencies most likely due to processing



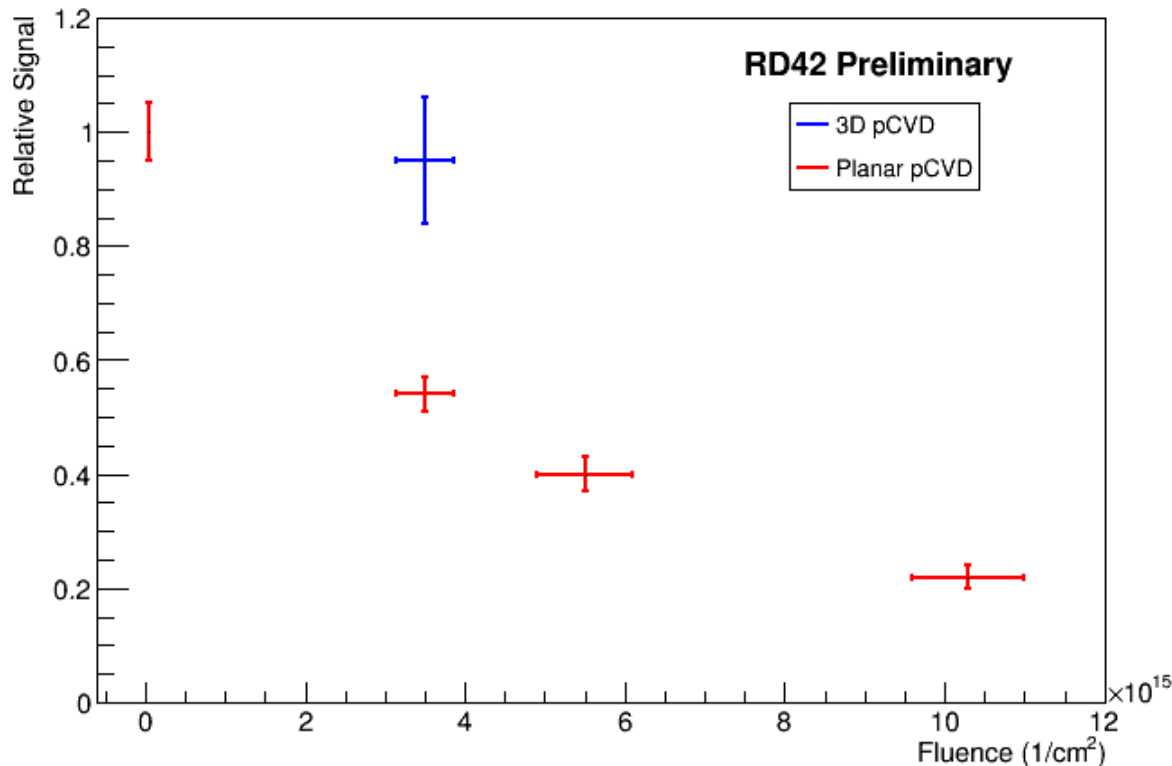


Highlights of Recent Work Accomplished

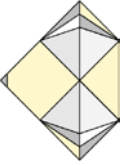
3D Diamond Pixel Detector Radiation Tolerance Results

Compare signal loss in 3D pixels to published results from planar

- 3D cells collect twice as much charge when unirradiated
- 3D sensors see $5 \pm 10\%$ signal reduction at $3.5 \times 10^{15} \text{ p/cm}^2$
- Planar sensors see $45 \pm 5\%$ signal reduction at $3.5 \times 10^{15} \text{ p/cm}^2$

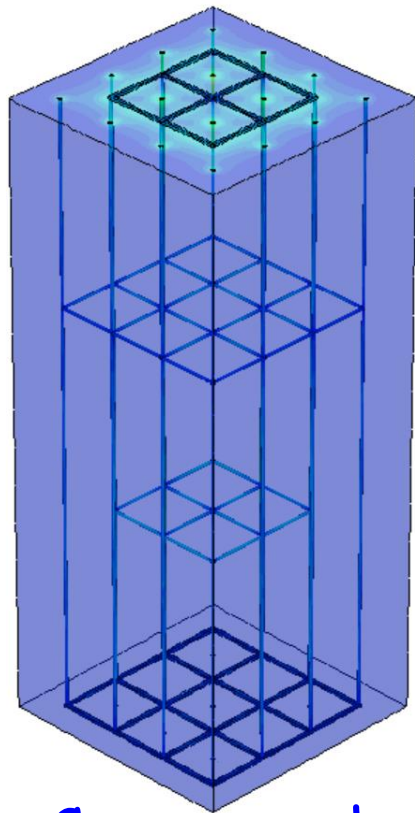


This result together with Universal curve imply 3D diamond devices should be able to operate at $10^{17}/\text{cm}^2$



Highlights of Recent Work Accomplished

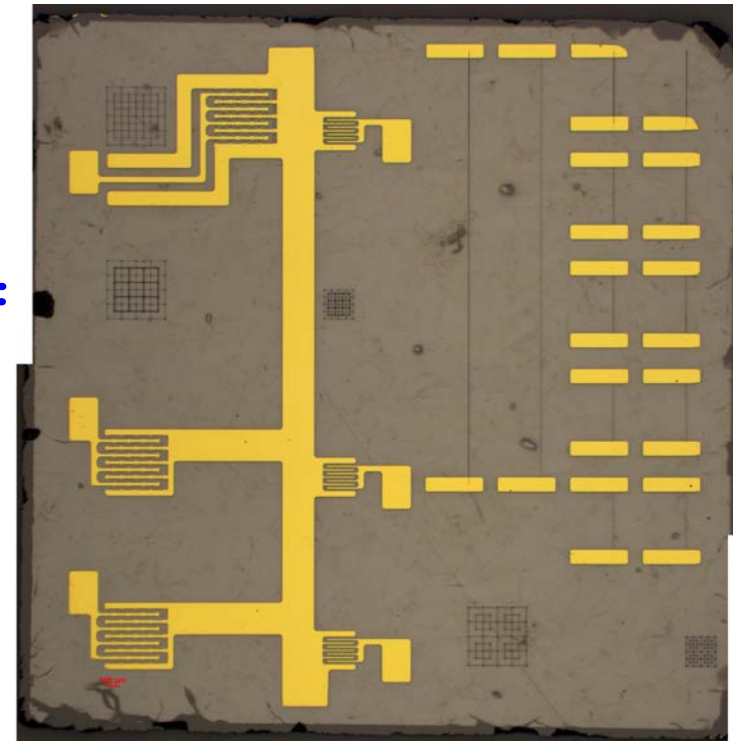
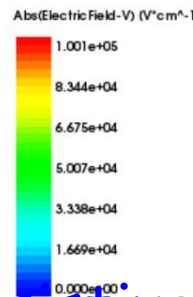
3D diamond devices are expected to make extreme radiation tolerant devices - What about redundancy?



+

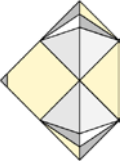


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Can we make resistive lines in the diamond bulk? YES!!!

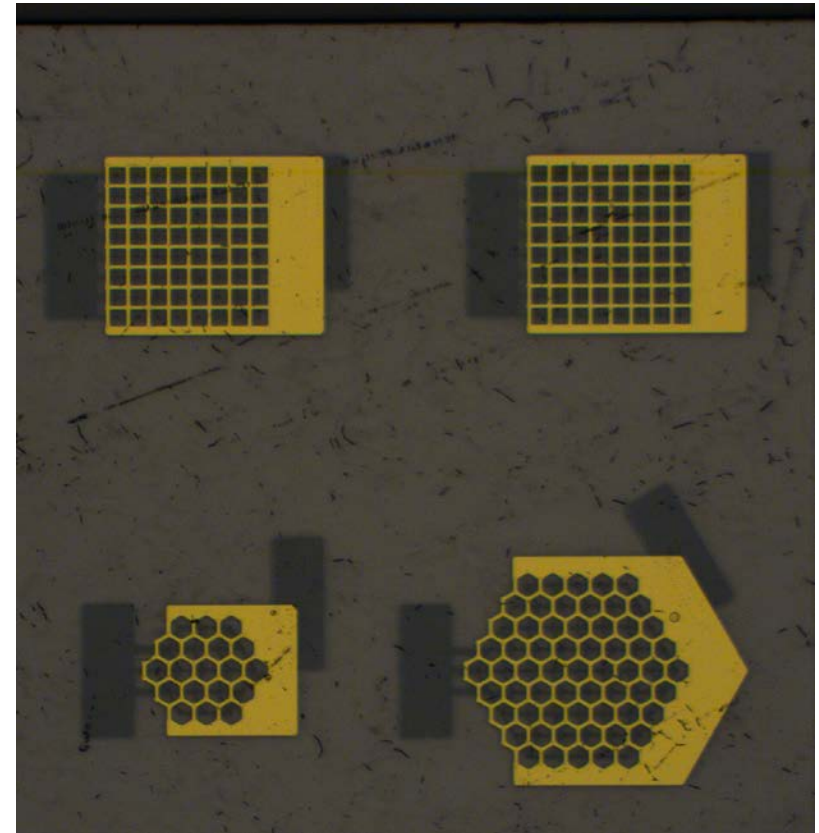
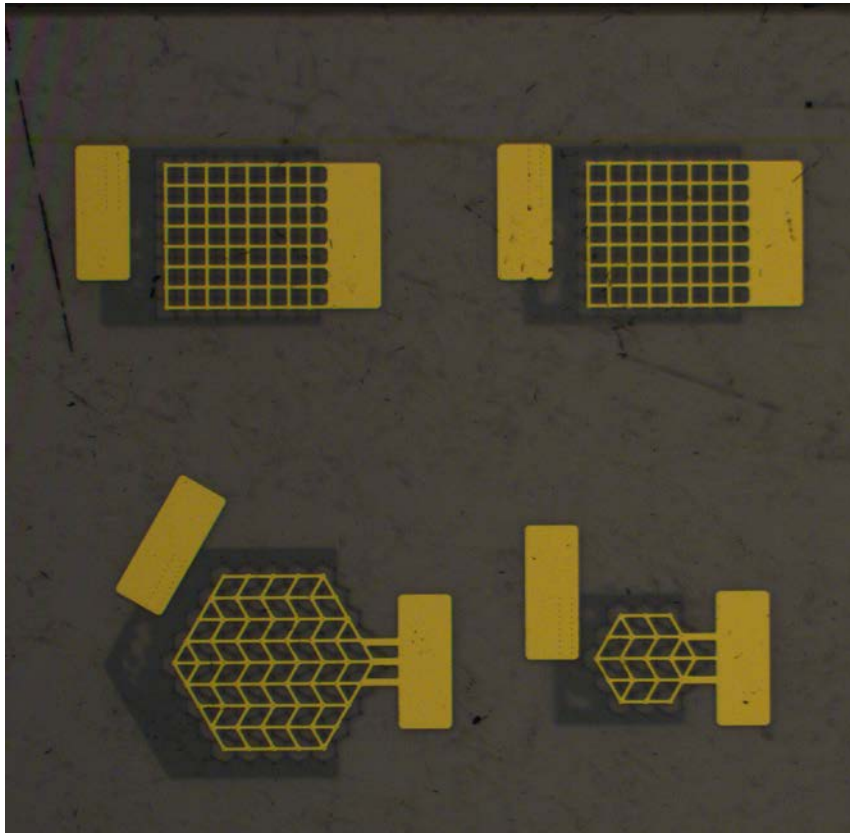
Can we make thru-hole vias? YES!!!



Highlights of Recent Work Accomplished

New 3D Diamond Detector Designs w/grids and vias for extremely radiation tolerant reliable beam devices

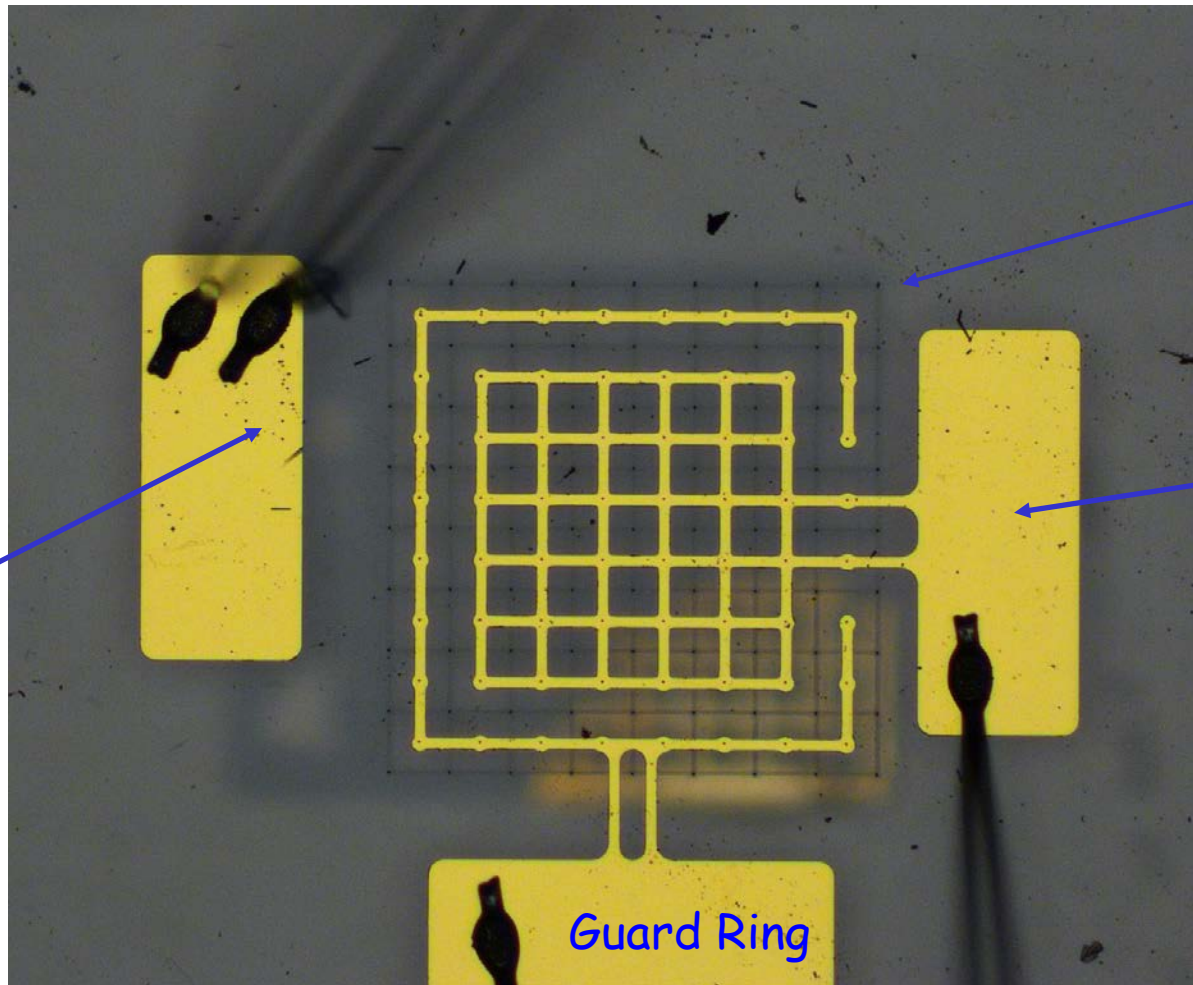
BCM' Devices Top/Readout side BCM' Devices Bot/HV side





Highlights of Recent Work Accomplished

New 3D Diamond Detector Designs w/grids and vias

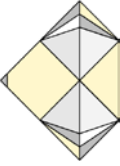


Through hole vias (HV)

Internal Cage/grid

Ganged Readout

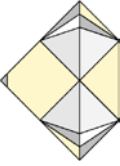
Guard Ring



Highlights of Recent Work Accomplished

Possible Extensions of this Work

- Grids/cages together with through-hole-vias allow the possibility of biased structures in the bulk of the diamond
- This is a prerequisite for developing a gain structure based on Impact Ionization



The RD42 Proposed Program

RD42 proposes a three-year program. The elements are:

7.1: 3D Diamond Sensor Fabrication and Characterisation

7.2: HL-LHC Beam Monitoring Proof-of-Principle

7.3: Development of pCVD Diamond Material

7.4: Development of 3D Diamond Pixel Modules

The program begins with the red and yellow milestones from the 2019-2021 program with additional milestones based on what we have recently learned. The details are in the report.

RD42 Summary



- **Radiation Tolerance**
 - Understood and published up to 10^{16}
 - Next step is to go to 10^{17}
- **Beam Monitors for the HL-LHC**
 - Calypso readout chip will most likely be used by ATLAS and CMS
 - ATLAS BCM' will use diamond planar pads, diamond 3D and silicon
 - CMS BCM' will use silicon pads
- **3D diamond sensors work well**
 - Unirradiated 3D sensors have twice the charge of planar sensors
 - Irradiated sensors have significantly less charge loss than planar
- **RD42 played a pivotal role in making all this happen!**